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Nov. 20, 2013 Sang-Soo Oh (KERI) Teruo Izumi (ISTEC)

Summary of Wires, Tapes & Characterization Talks in ISS 2013

Statistics of Oral Session

Plenary Talks : 2 for REBCO (Japan, US)

Categories of Oral Session

- Nb3Sn : 1
- ▶ REBCO : 20
- **BSCCO : 2**
- ▶ MgB2 : 3
- Other materials : 3
- Total Presentation No.(Oral) : 29

AC-loss Reduction in PLD Tape by Multi-filamentation



Loss reduction of 1/10 was confirmed in 100m tape.

T.Izumi(ISTEC-SRL)

ISTEC /

WT-5-INV A. Ibi et al. WT-14-INV T. Machi et al.

Hot News!!!!! 94m long C.C. with thick EuBCO + BHO film



Delamination



T₅.Izumi(ISTEC-SRL)

WT-12-INV M. Yoshizumi et al.

New 1.2µm HTS Wires Optimized for Application Specific Operating Conditions amsc





High temperature, low field applications

N. Strickland - Callaghan Innovation

V.Selvamanickman(U. of Huston)

4.0 1T ♦ 77K 3.5 – 70K - 60K 50K 3.0 35K I_ε[Т,Н] / I_ε[77К,sf] 2.5 2.0 -1.5 1.0 0.5 0.0 30 60 90 120 150 180

1.2µm Coil Wire

Field Orientation (deg)

Low temperature, perpendicular field applications



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4X HTS conductor performance improvement targeted for high power wind generators

- ARPA-E REACT program targeted on 10 MW wind generator operating at 30 K, 2.5 T
- Improved approaches to engineer nanoscale defects in coated conductors
- New pilot MOCVD system set up in UH Energy Research Park to rapidly scale up new technology advances to long-length manufacturing.



Engineered nanoscale defects



4x improved wire manufacturing



High-power, Efficient

- Quadrupling superconductor Performance at 30 K, 2.5 T for^{Wind Turbines} commercialization of 10 MW wind generators to reduce wire cost by 4x
- Advances will also lead to high-performance HTS conductors for other high-field applications

V.Selvamanickman(U. of Huston) **TECO** Westinghouse



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At 77 K, 15%Zr-added tape superior to the best 7.5%Zr-added tape measured to date





Y.Iijima(Fujikura Ltd.)





BASF GmbH owner



Ink-jet printing in continuous

processing

- CSD for all layers is considered to be the "most promising and most challenging process
- Unique and protected CSD-multilayer technology, IJP.
- Established industrial cooperations on metallic substrates (Thyssen Krupp), coating solutions (Honeywell) and insulation (Elektrisola)



deutsche

nanoschicht





All samples continuously processed in minimum 10 m lengths

- ✓ J_c (77K, sf) = 1.2 -1.8 MA/cm² for 1 µm HTS
- ✓ 7mm wide slitted and stabilized sample, I_c /cm-w > 160A









3D reconstruction of GdBCO and EuBCO with BHO nano-rods

-3.5mol%BHO-GdBCO(*I_c* = 705 A/cm@77 K , self; 2.9 μm-thick)







S. Awaji (Tohoku U.)

Short Summary: effect of fabrication process on delamination





	Origin of delamination	strength	Reason of weakness	Way to overcome
1	RE123	>50MPa		
2	GZO	<20MPa	Pores in MOD-GZO	Optimization of MOD conditions
3	Near substrate	<50MPa	Oxygenation during buffer and REBCO layers deposition	Fast deposition Low deposition temp.



M. Yoshizumi (ISTEC-SRL)



Superconductivity Research Laboratory (SRL) - ISTEC

Information along Width (RTR-SHPM)



Conclusion

- Low cost processes for commercial CC were presented.
- Higher in-field properties of CC have been demonstrated by artificial pinning center technology with BZO or BHO in US, Japan, EU.
- Low AC loss CC tape was demonstrated in long length in Japan.
- Delamination behaviors of CC were systematically evaluated.
- Various advanced characterization technologies for CC were presented.
- CC with nano APC was well analyzed and described by TEM and a pinning theory, respectively.
- 16% Sn added Nb3Sn contributed to the 930 MHz NMR.
- Mechanical property was improved in DI-BSCCO tape.
- Progresses of MgB2 and iron-based wire were also presented.